Announcement

INTERNATIONAL SOCIETY FOR HYBRID MICROELECTRONICS

The International Society for Hybrid Microelectronics is based in the U.S.A., and there are independent parallel organisations throughout the world. These groups are independent, non-profitmaking organisations, the purpose of which is to provide an informal means of discussing and advancing hybrid technology. This is achieved by the organisation of meetings, the publication of a Newsletter and other activities as appropriate. Membership is open to all and there are no formal entry requirements.

All these societies run a programme of meetings throughout the year on subjects concerned with thick films, and interested readers are advised to contact the following Chairmen for details of meetings in their own areas:

1. Benelux
   Mr G. K. Steenvoorden
   Technische Hogeschool Delft
   Lorentzweg 1
   NL 2628 C J DELFT
   Nederland

2. France
   Dr B. Dreyfus-Alain
   President de I.F.M.H.
   114 Rue de Damiette
   91190 GIF SUR YVETTE, France

3. Germany
   Herr W. Funk
   Chairman I.S.H.M. Deutschland
   Reinekestrasse 22
   8000 MUNCHEN 90
   W. Germany

4. Italy
   Dr D. Roggia,
   Telettra
   Via Trento 30
   20059 VIMERCATE
   Italy

5. Japan
   Dr A. Ikegami
   Hitachi Ltd.,
   292 Yoshida-Cho
   Totsuka-ku,
   YOKOHAMA,
   Japan.

6. Nordic
   Mr E. Järvinen
   Technical Research Centre of Finland
   Electronics Laboratory
   POB 181
   SF 90101 OULU
   Finland

7. U.K.
   Dr J. T. Law
   Bio-engineering Unit
   Princess Margaret Rose Hospital
   Fairmile Head
   EDINBURGH
   Scotland
   Great Britain

8. U.S.A. – all U.S. Chapters
   I.S.H.M.
   P.O. Box 3255
   MONTGOMERY
   Alabama 36109, U.S.A.

In addition, the European Chapters are all linked together through the European Liaison Committee, Chairman:

Prof. R. Govaerts,
Instituut Elektrotechniek,
K. U. Leuven,
Kardinal Mercierlaan 94,
B-3030 HEVERLEE, Belgium.